

## Features

- 40V/280A,  
 $R_{DS(ON)} = 1.1m\Omega(Typ.)@V_{GS}=10V$   
 $R_{DS(ON)} = 1.9m\Omega(Typ.)@V_{GS}=4.5V$
- Ultra Low  $R_{DS(ON)}$
- Super High Dense Cell Design
- High Current Capability
- 100% Avalanche Tested

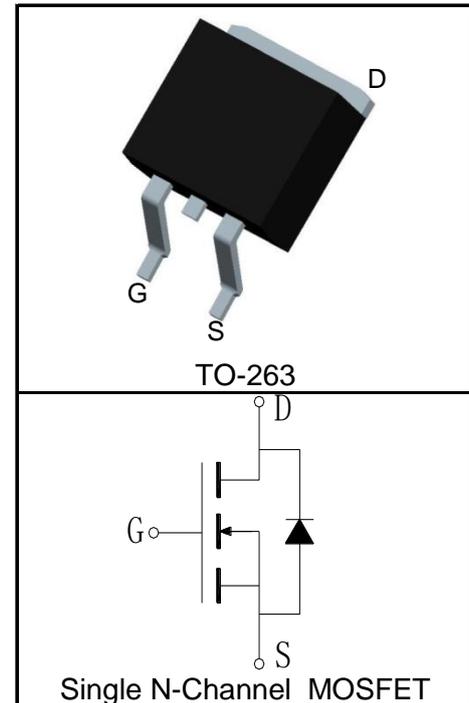
## Applications

- Energy Storage
- High power density point of load converters
- High efficiency DC/DC Converters



Halogen-Free

## Pin Description



## Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
<b>Common Ratings</b> ( $T_C=25^\circ\text{C}$ Unless Otherwise Noted)			
$V_{DSS}$	Drain-Source Voltage	40	V
$V_{GSS}$	Gate-Source Voltage	$\pm 20$	
$T_J$	Maximum Junction Temperature	175	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 175	$^\circ\text{C}$
$I_S$	Diode Continuous Forward Current	$T_C=25^\circ\text{C}$ 280	A
<b>Mounted on Large Heat Sink</b>			
$I_{DP}^{(1)}$	300 $\mu\text{s}$ Pulse Drain Current Tested	$T_C=25^\circ\text{C}$ 1120	A
$I_D^{(2)}$	Continuous Drain Current( $V_{GS}=10V$ )	$T_C=25^\circ\text{C}$ 280	A
		$T_C=100^\circ\text{C}$ 198	
$P_D$	Maximum Power Dissipation	$T_C=25^\circ\text{C}$ 254	W
		$T_C=100^\circ\text{C}$ 127	
$R_{\theta JC}$	Thermal Resistance-Junction to Case	0.59	$^\circ\text{C/W}$
$R_{\theta JA}^{(3)}$	Thermal Resistance-Junction to Ambient	62.5	$^\circ\text{C/W}$
<b>Drain-Source Avalanche Ratings</b>			
$E_{AS}^{(4)}$	Avalanche Energy, Single Pulsed	992	mJ

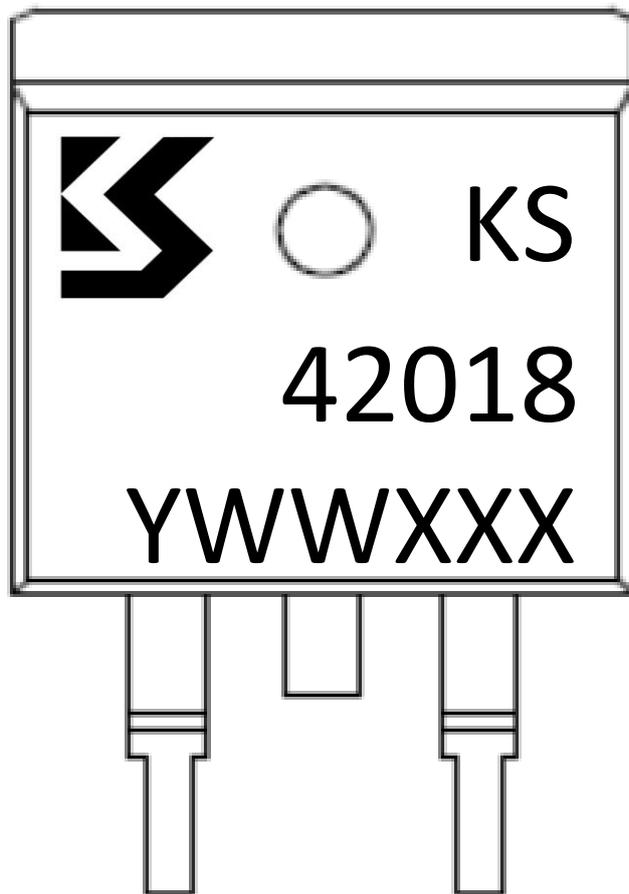
**Electrical Characteristics** ( $T_C=25^\circ\text{C}$  Unless Otherwise Noted)

Symbol	Parameter	Test Condition	KS42018GA			Unit
			Min.	Typ.	Max.	
<b>Static Characteristics</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_{DS}=250\mu A$	40			V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=40V, V_{GS}=0V$			1	$\mu A$
		$T_J=125^\circ\text{C}$			100	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_{DS}=250\mu A$	1.1	1.6	2.3	V
$I_{GSS}$	Gate Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			$\pm 100$	nA
$R_{DS(ON)}^{(5)}$	Drain-Source On-state Resistance	$V_{GS}=10V, I_{DS}=20A$		1.1	1.8	$m\Omega$
		$V_{GS}=4.5V, I_{DS}=15A$		1.9	2.6	$m\Omega$
<b>Diode Characteristics</b>						
$V_{SD}^{(5)}$	Diode Forward Voltage	$I_{SD}=20A, V_{GS}=0V$		0.76	1.2	V
$t_{rr}$	Reverse Recovery Time	$I_{SD}=20A, di_{SD}/dt=100A/\mu s$		44		ns
$Q_{rr}$	Reverse Recovery Charge			95		nC
<b>Dynamic Characteristics<sup>(6)</sup></b>						
$R_G$	Gate Resistance	$V_{GS}=0V, V_{DS}=0V, F=1\text{MHz}$		1.4		$\Omega$
$C_{iss}$	Input Capacitance	$V_{GS}=0V, V_{DS}=20V, \text{Frequency}=1.0\text{MHz}$		10950		pF
$C_{oss}$	Output Capacitance			1100		
$C_{rss}$	Reverse Transfer Capacitance			815		
$t_{d(ON)}$	Turn-on Delay Time	$V_{DD}=20V, I_{DS}=20A, V_{GEN}=10V, R_G=3\Omega$		26		ns
$t_r$	Turn-on Rise Time			77		
$t_{d(OFF)}$	Turn-off Delay Time			155		
$t_f$	Turn-off Fall Time			41		
<b>Gate Charge Characteristics<sup>(6)</sup></b>						
$Q_g$	Total Gate Charge	$V_{DS}=20V, V_{GS}=10V, I_{DS}=20A$		161		nC
$Q_{gs}$	Gate-Source Charge			29		
$Q_{gd}$	Gate-Drain Charge			32		

- Notes:
- ① Pulse width limited by safe operating area.
  - ② Calculated continuous current based on maximum allowable junction temperature. The package limitation current is 75A.
  - ③ When mounted on 1 inch square copper board,  $t \leq 10\text{sec}$ . The value in any given application depends on the user's specific board design.
  - ④ Limited by  $T_{Jmax}$ ,  $I_{AS}=63A, L=0.5\text{mH}, V_{DD}=30V, R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$ .
  - ⑤ Pulse test; Pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
  - ⑥ Guaranteed by design, not subject to production testing.

**Ordering and Marking Information**

Device	Package	Packaging	Quantity	Reel Size	Tape width
KS42018GA	TO-263	Tape&Reel	800	13"	24mm

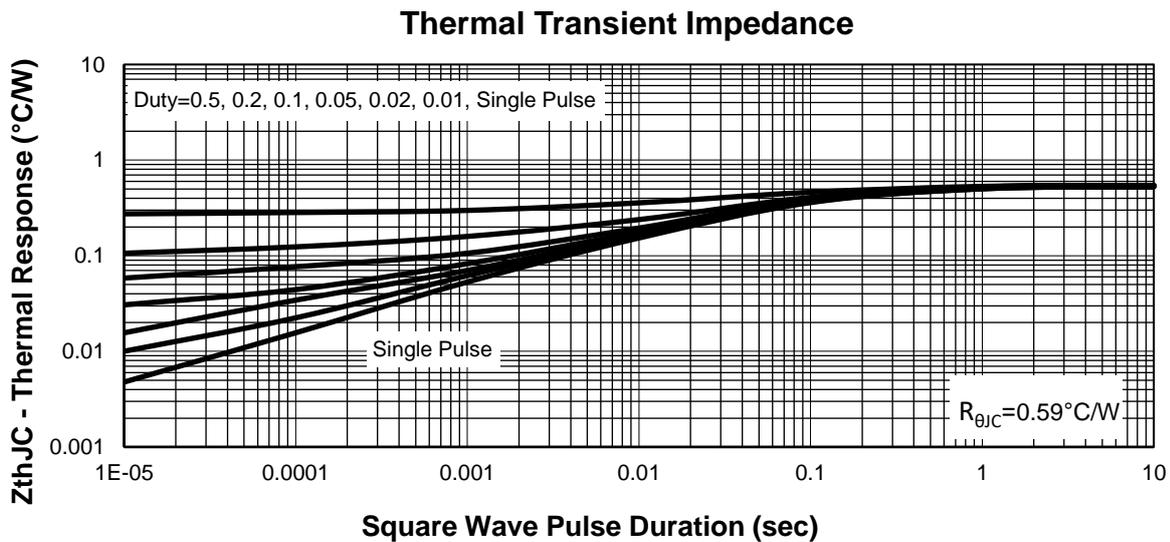
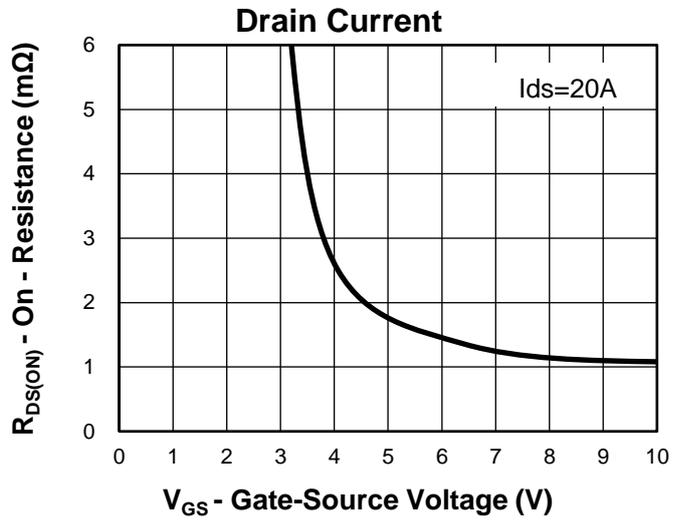
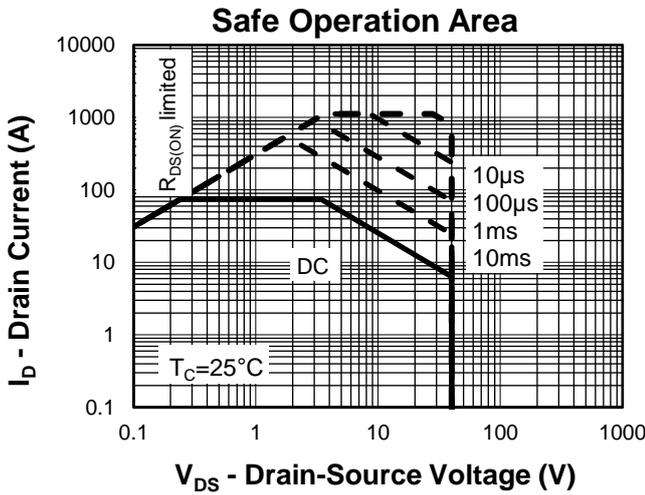
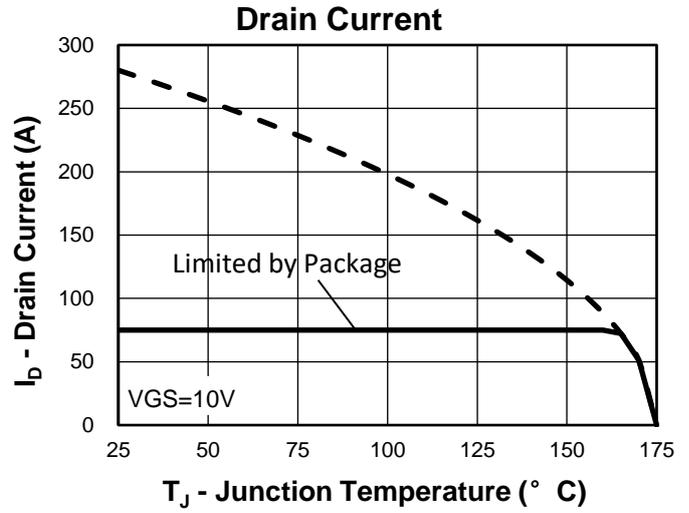
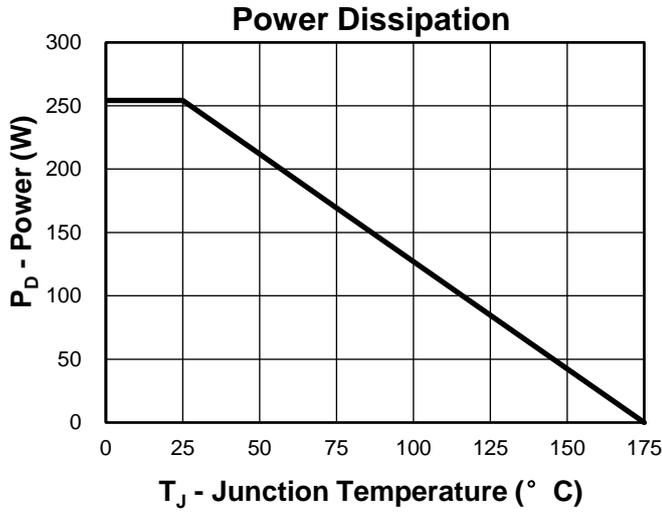


1st Line: Kwansemi LOGO, Kwansemi Code(KS)

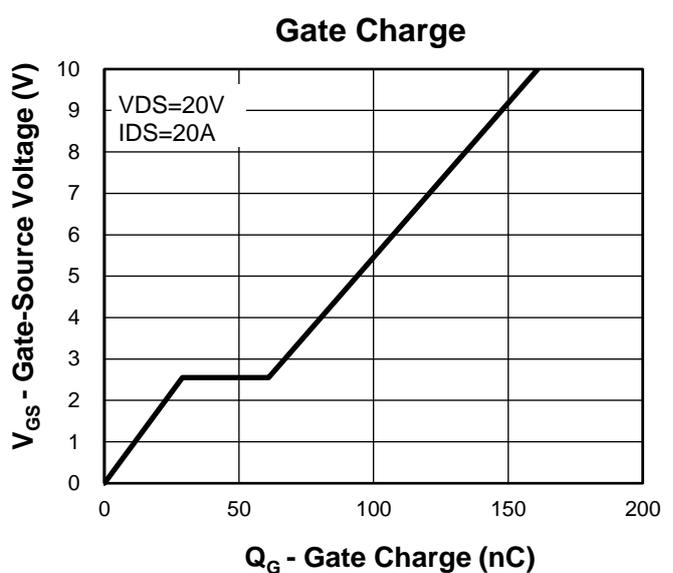
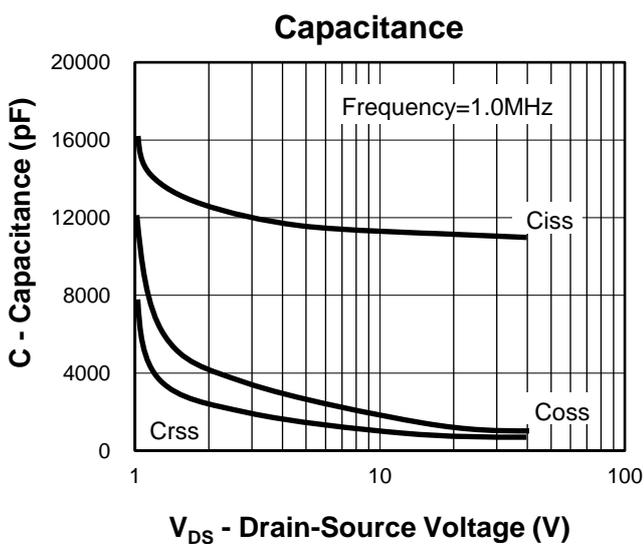
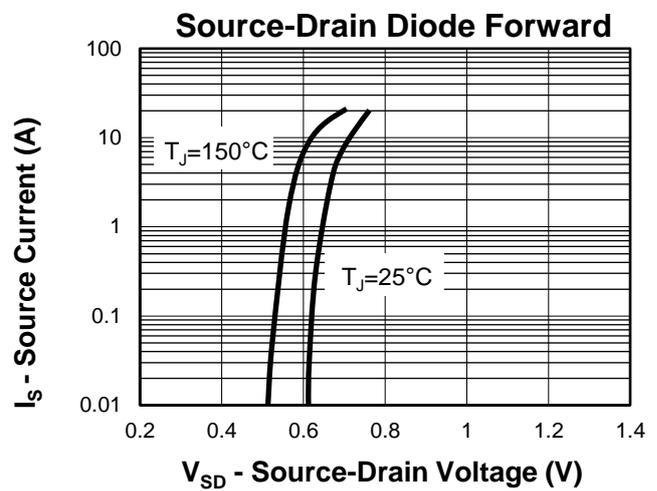
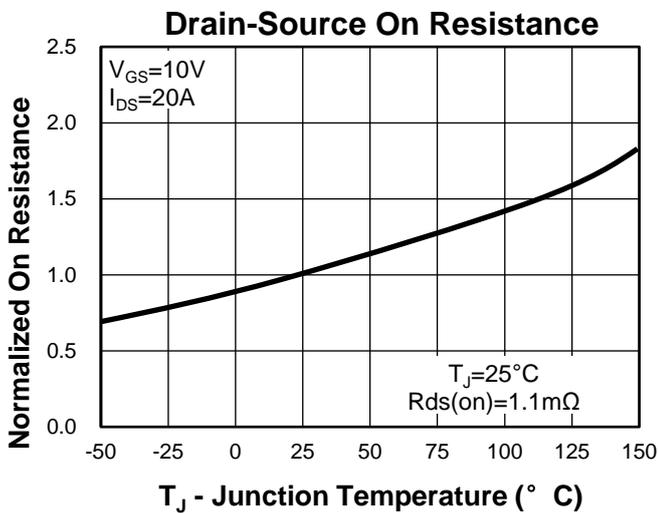
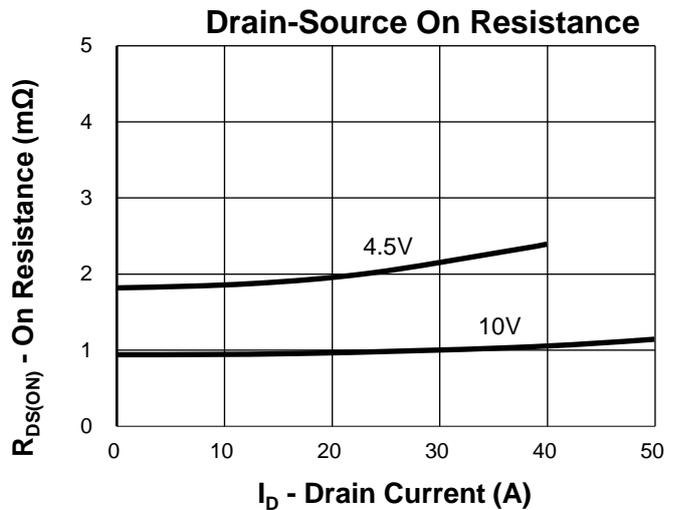
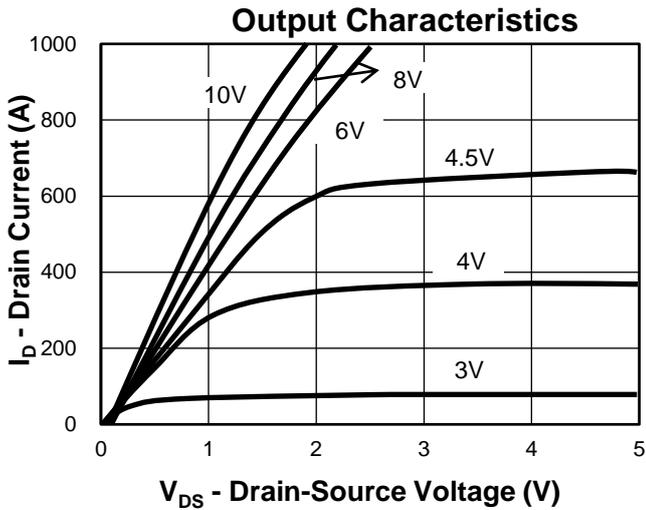
2nd Line: Part Number(42018)

3rd Line: Lot Number(YWWXXX)

Typical Characteristics

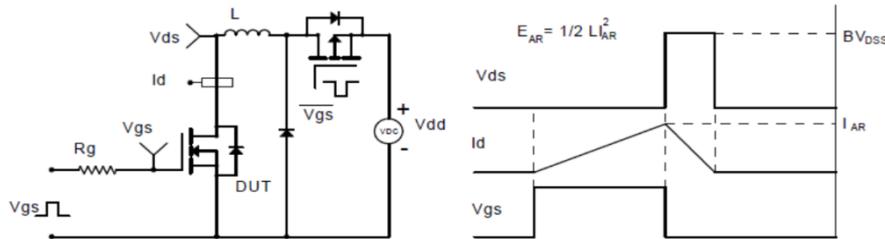


### Typical Characteristics

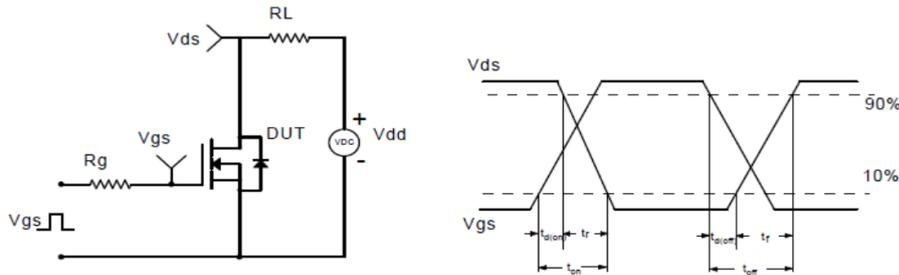




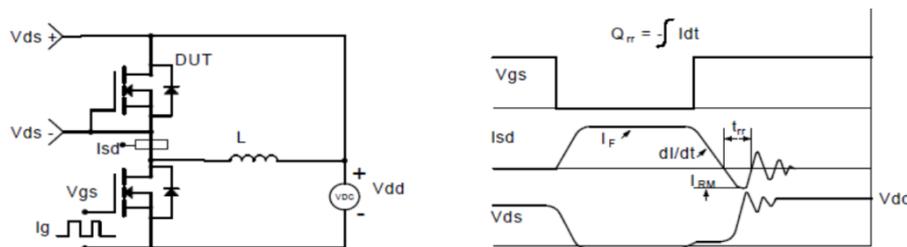
### Avalanche Test Circuit and Waveforms



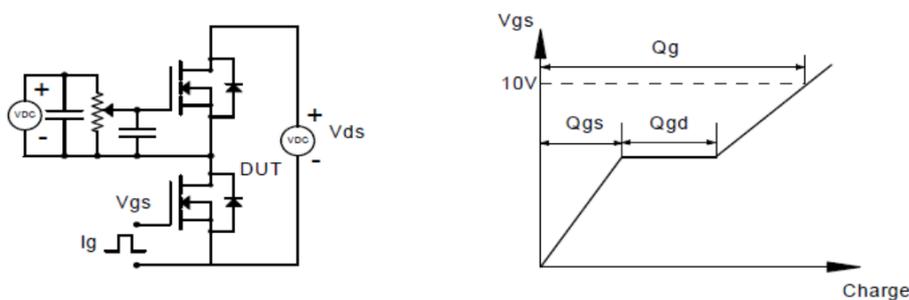
### Switching Time Test Circuit and Waveforms



### Diode Recovery Test Circuit and Waveforms



### Gate Charge Test Circuit and Waveform



### Customer Service

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